

Material Declaration Data Sheet

Model: Server Chassis SBXD62 Manufacturer: Intel Corporation

Note: This declaration applies to all associated product codes noted on Page 2

Lead Free (Pb) Product: No Revision Date: 05/15/2006

Restriction on Hazardous Substances (RoHS) Compliance

RoHS Definition

- Quantity limit of 0.1% by mass (1000PPM) for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE)
- Quantity limit of 0.01% by mass (100 PPM) for: Cadmium

Intel understands RoHS requires: Lead and other materials banned in the RoHS Directive are either (1) below all applicable substance thresholds as proposed by the EU or (2) an approved/pending exemption applies. (Note: RoHS implementing details are not fully defined and may change.) RoHS Declaration

\boxtimes	1. Lead in glass of cathode ray tubes, electronic components and fluorescent tubes
	2. Lead as an alloying element in steel containing up to 0.35% lead by weight
	3. Lead as an alloying element in aluminum containing up to 0.4% lead by weight
	4. Lead as an alloying element in copper containing up to 4% lead by weight
	5. Lead in high melting temperature type solders (i.e. lead based alloys containing 85% by weight or more lead).
\boxtimes	6. Lead in solders for servers, storage and storage array systems, network infrastructure equipment
	for switching, signaling, transmission as well as network management for telecommunications.
\boxtimes	7. Lead in electronic ceramic parts (e.g. piezoelectronic devices)
	8. Lead used in compliant pin connector systems
	9. Lead as a coating material for the thermal conduction module c-ring
	10. Lead in optical and filter glass
\boxtimes	11. Lead in solders consisting of more than two parts for the connection between the pins and the
	package of microprocessors with a lead content of more than 80% and less than 85% by weight
\boxtimes	12. Lead in solders to complete a viable electrical connection between semiconductor die and carrier
	within integrated circuit Flip Chip packages
	13. Cadmium in optical and filter glass
\boxtimes	14. Cadmium and its compounds in electrical contacts and cadmium plating except for applications
	banned under Directive 91/338/EEC (*) amending Directive 76/769/EEC (**) relating to restrictions on
	the marketing and use of certain dangerous substances and preparations
	15. Lead in bronze bearing shells and brushes
	16. Other

Where the product is declared to meet RoHS requirements, it has been verified to be in conformance with 2002/95/EC as we currently understand the requirements. Intel has systems in place to verify conformance with all applicable environmental requirements and to the best of our knowledge the information is true and correct.

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Product Code Information

Product Code	Description	*RoHS Exemption #
SBXD62	Firefly Blade	1,4,5,6,7,11,12,14
ABSHSX	Heat Sink	
AB73SAS	73GB SAS Drive	1,4,5,7,11,12,14
AB36SAS	36GB SAS Drive	1,4,5,7,11,12,14

^{*} RoHS exemption # corresponds with exemption #'s found on page 1